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3729
PATENT

Docket No. 1948-4631

THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s) : NICOLAI et al.

Group Art Unit: 3729

Serial No. : 09/423,075

Examiner: S. Smith

Filed : November 1, 1999

For : SHIELDING AN ELECTRONIC CARD WITH PRINTED CIRCUIT
MOUNTED ON A METAL SUBSTRATE

CERTIFICATE OF MAILING (37 C.F.R. 1.8a)

Commissioner for Patents
Washington, D.C. 20231

Sir:

I hereby certify that the following attached papers

1. Amendment; and
2. Return postcard.

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USPTO MAIL ROOM

(along with any papers referred to as being attached or enclosed) and this Certificate of Mailing are being deposited with the United States Postal Service on the date shown below with sufficient postage as first-class mail in an envelope addressed to the: Commissioner for Patents, Washington, D.C. 20231.

Respectfully submitted,

MORGAN & FINNEGAN

Date: January 24, 2002
By: Richard D. Ratchford Jr.
Richard D. Ratchford Jr.

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#10/Amo
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Commissioner for Patents
Washington, DC 20231

Sir:

This Amendment is submitted in response to the Office Action dated October 24, 2001,
Applicants respectfully request consideration of the above-identified application in view of the
following amendments and remarks.

IN THE SPECIFICATION

At page 1, at line 3 please insert:

31

--FIELD OF THE INVENTION--

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At page 1, at line 10 please insert:

32

--BACKGROUND OF THE INVENTION--

At page 1, please delete the fifth full paragraph commencing at line 15 and insert
therefor:

33
-According to a first type of solution, the electrical connection of the metal cover to
ground which the metal substrate constitutes is formed independently of the mechanical fixing of
the cover with respect to the substrate and to the electronics card. For example, the electrical